Vishay Siliconix



| THERMAL RESISTANCE RATI | NGS | | | | | | | | |
|---|-----------------------|---|--|--------------------|-----------|-----------|----------------------|------------------|--|
| PARAMETER | SYMBOL | TYP | | MAX. | | | UNIT | | |
| Maximum Junction-to-Ambient | R _{thJA} | - 62 0.50 - - 0.50 | | | | | | | |
| Case-to-Sink, Flat, Greasd Surface | R _{thCS} | | | °C/W | | | | | |
| Maximum Junction-to-Case (Drain) | R _{thJC} | | | | | | | | |
| | | | | | | | | | |
| SPECIFICATIONS (T _J = 25 °C, u | nless otherw | ise noted) | | | | | | | |
| PARAMETER | SYMBOL | TEST CONDITIONS | | MIN. | TYP. | MAX. | UNIT | | |
| Static | | | | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | V _{GS} = | = 0 V, I _D = 25 | 0 μΑ | 500 | - | - | V | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | Reference to 25 °C, I _D = 1 mA | | - | 0.55 | - | V/°C | | |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = 250 \ \mu A$ | | 2.0 | - | 4.0 | V | | |
| Gate-Source Leakage | I _{GSS} | $V_{GS} = \pm 30 \text{ V}$ | | - | - | ± 100 | nA | | |
| | | $V_{DS} = 500 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ | | | - | - | 25 | μA | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 400 V, V _{GS} = 0 V, T _J = 125 °C | | - | - | 250 | | | |
| Drain-Source On-State Resistance | R _{DS(on)} | V _{GS} = 10 V | I _D = | 8.4 A ^b | - | - | 0.450 | Ω | |
| Forward Transconductance | 9 _{fs} | $V_{DS} = 50 \text{ V}, \text{ I}_{D} = 8.4 \text{ A}$ | | 8.1 | - | - | S | | |
| Dynamic | | | | | 1 | I | I | 1 | |
| Input Capacitance | C _{iss} | $V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0 MHz, see fig. 5 | | - | 1910 | - | | | |
| Output Capacitance | Coss | | | - | 290 | - | | | |
| Reverse Transfer Capacitance | C _{rss} | | | - | 11 | - | | | |
| Output Capacitance | C _{oss} | | V _{DS} = 1.0 \ | /, f = 1.0 MHz | - | 2730 | - | pF | |
| | | $V_{GS} = 0 V$ | V _{DS} = 400 V | /, f = 1.0 MHz | - | 82 | - | 1 | |
| Effective Output Capacitance | C _{oss} eff. | | $V_{DS} = 0 \text{ V to } 400 \text{ V}^{c}$ | | - | 160 | - | 1 | |
| Total Gate Charge | Qg | | | | - | - | 81 | | |
| Gate-Source Charge | Q _{gs} | | $I_D = 14 \text{ A}, V_{DS} = 400 \text{ V},$ see fig. 6 and 13^{b} | | - | - | 20 | nC | |
| Gate-Drain Charge | Q _{gd} | | | | - | - | 36 | | |
| Turn-On Delay Time | t _{d(on)} | V _{GS} = 10 V | V _{DD} = 250 V, I _D = 14 A, R _g = 7.5 Ω, see fig. 10 ^b | | - | 15 | - | - ns | |
| Rise Time | t _r | | | | - | 39 | - | | |
| Turn-Off Delay Time | t _{d(off)} | | | | - | 39 | - | | |
| Fall Time | t _f | | | - | - | 31 | - | | |
| Drain-Source Body Diode Characteristic | s | | | | | | | • | |
| Continuous Source-Drain Diode Current | I _S | MOSFET symbol showing the integral reverse p - n junction diode | | - | - | 14 | A | | |
| Pulsed Diode Forward Current ^a | I _{SM} | | | - | - | 56 | | | |
| Body Diode Voltage | V_{SD} | $T_J = 25 \text{ °C}, I_S = 14 \text{ A}, V_{GS} = 0 \text{ V}^{b}$ | | - | - | 1.5 | V | | |
| Body Diode Reverse Recovery Time | t _{rr} | $T_J = 25 \text{ °C}, I_F = 14 \text{ A},$ $T_J = 125 \text{ °C}, dl/dt = 100 \text{ A}/\mu \text{s}^{\text{b}}$ | | - | 370 | 550 | ns | | |
| Body Diode Reverse Recovery Charge | Q _{rr} | | | - | 4.4 | 6.5 | μC | | |
| Body Diode Reverse Recovery Current | I _{RRM} | | | - | 21 | 31 | Α | | |
| Forward Turn-On Time | t _{on} | Intrinsic tu | ırn-on time is | negligible (turn | on is dor | ninated b | y L _S and | L _D) | |

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

c. C_{oss} eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .

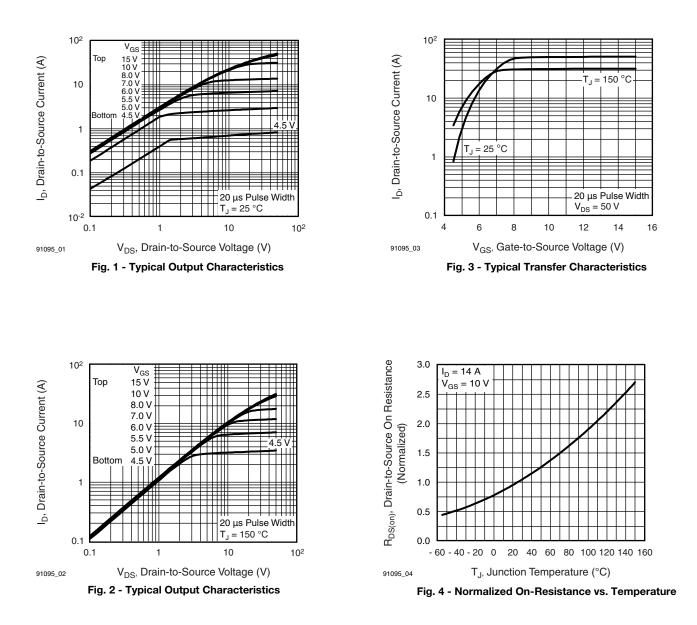
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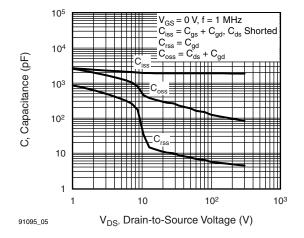


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

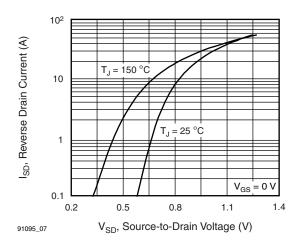


Fig. 7 - Typical Source-Drain Diode Forward Voltage

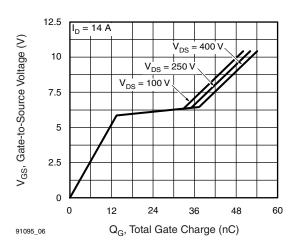


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

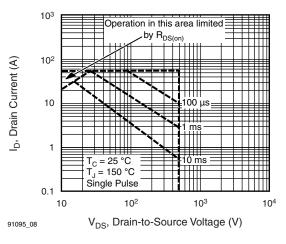


Fig. 8 - Maximum Safe Operating Area

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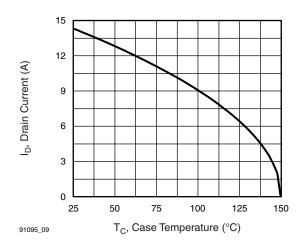


Fig. 9 - Maximum Drain Current vs. Case Temperature

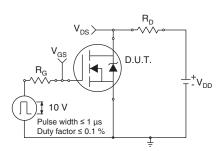


Fig. 10a - Switching Time Test Circuit

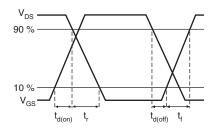


Fig. 10b - Switching Time Waveforms

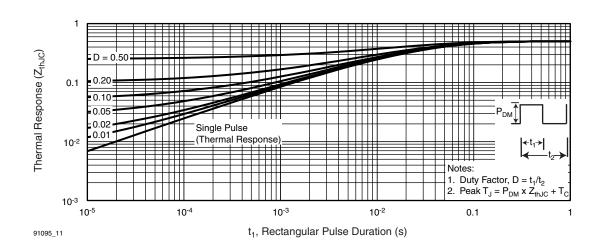


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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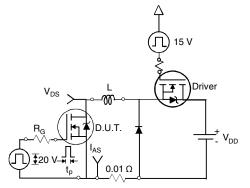


Fig. 12a - Unclamped Inductive Test Circuit

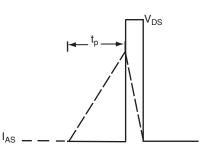


Fig. 12b - Unclamped Inductive Waveforms

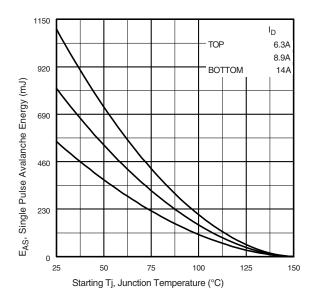
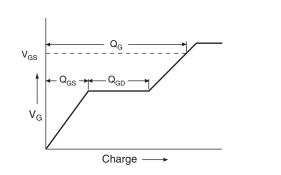


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





Current regulator Same type as D.U.1 50 kΩ 0.3 uł V_{DS} D.U.T. V_{GS} ; 3 m A 🕽 📗 \sim I_G I_D Current sampling resistors

Fig. 13b - Gate Charge Test Circuit

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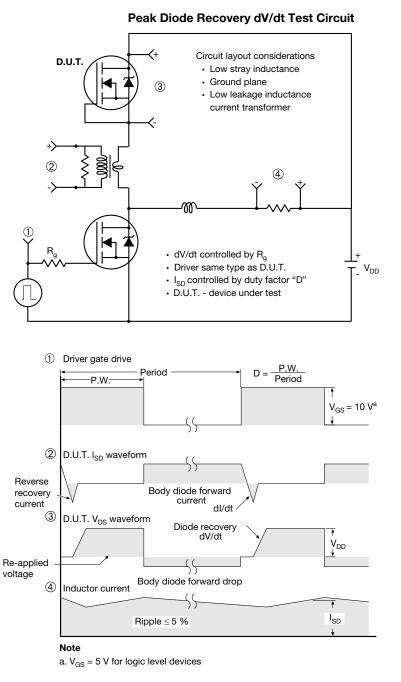


Fig. 14 - For N-Channel

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reliability data, see <u>www.vishay.com/ppg?91095</u>.

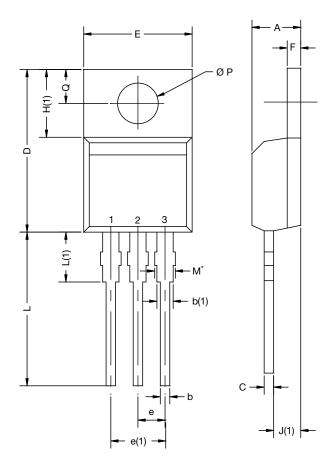
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TO-220-1



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| DIM. | MILLIN | IETERS | INCHES | | |
|-------|--------------|--------|--------|-------|--|
| DINI. | MIN. | MAX. | MIN. | MAX. | |
| А | 4.24 | 4.65 | 0.167 | 0.183 | |
| b | 0.69 | 1.02 | 0.027 | 0.040 | |
| b(1) | 1.14 | 1.78 | 0.045 | 0.070 | |
| С | 0.36 | 0.61 | 0.014 | 0.024 | |
| D | 14.33 | 15.85 | 0.564 | 0.624 | |
| Е | 9.96 | 10.52 | 0.392 | 0.414 | |
| е | 2.41 | 2.67 | 0.095 | 0.105 | |
| e(1) | 4.88 | 5.28 | 0.192 | 0.208 | |
| F | 1.14 | 1.40 | 0.045 | 0.055 | |
| H(1) | 6.10 | 6.71 | 0.240 | 0.264 | |
| J(1) | 2.41 | 2.92 | 0.095 | 0.115 | |
| L | 13.36 | 14.40 | 0.526 | 0.567 | |
| L(1) | 3.33 | 4.04 | 0.131 | 0.159 | |
| ØΡ | 3.53 | 3.94 | 0.139 | 0.155 | |
| Q | 2.54 | 3.00 | 0.100 | 0.118 | |
| - | 0364-Rev. C, | | 0.100 | 0.118 | |

Note

- M^{\star} = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

| Package Picture | | | | | | | |
|-----------------|-------|--|--|--|--|--|--|
| ASE | Xi'an | | | | | | |
| | | | | | | | |

Revison: 14-Dec-15

Document Number: 66542

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